

ON Semiconductor®

J109 / MMBFJ108 N-Channel Switch

Features

- This device is designed for digital switching applications where very low on resistance is mandatory.
- Sourced from process 58

Ordering Information



Figure 1. J109 Device Package

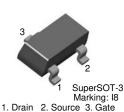


Figure 2. MMBFJ108 Device Package

Part Number	Top Mark	Package	Packing Method
J109	J109	TO-92 3L	Bulk
J109-D26Z	J109	TO-92 3L	Tape and Reel
MMBFJ108	18	SSOT 3L	Tape and Reel

Absolute Maximum Ratings^{(1), (2)}

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{DG}	Drain-Gate Voltage	25	V
V _{GS}	Gate-Source Voltage	-25	V
I _{GF}	Forward Gate Current	10	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C

Notes:

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. ON Semiconductor should be consulted on applications involving pulsed or lowduty-cycle operations.

Thermal Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Ma	Unit		
Symbol		J109 ⁽³⁾	MMBFJ108 ⁽⁴⁾	Unit	
PD	Total Device Dissipation	625	350	mW	
	Derate Above 25°C	5.0	2.8	mW/°C	
R _{0JC}	Thermal Resistance, Junction-to-Case	125		°C/W	
R _{0JA}	Thermal Resistance, Junction-to-Ambient	200	357	°C/W	

Notes:

3. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size. 4. Device mounted on FR-4 PCB 36mm × 18mm × 1.5mm; mounting pad for the collector lead minimum 6 cm^2 .

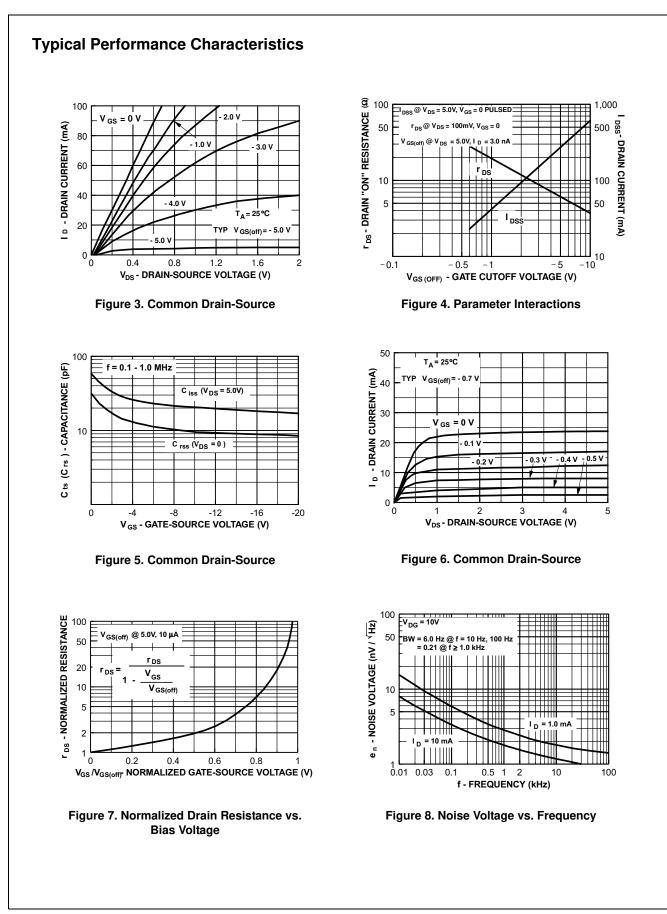
Electrical Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions		Min.	Max.	Unit
Off Charac	teristics				•	
V _{(BR)GSS}	Gate-Source Breakdown Voltage	$I_{G} = -10 \ \mu A, \ V_{DS} = 0$		-25		V
I _{GSS}	Gata Povorca Current	$V_{GS} = -15 V, V_{DS} = 0$			-3.0	nA
	Gate Reverse Current	$V_{GS} = -15 \text{ V}, V_{DS} = 0, T_A = 100^{\circ}\text{C}$			-200	
V _{GS} (off)	Gate-Source Cut-Off Voltage	V _{DS} = 15 V, I _D = 10 nA	MMBFJ108	-3.0	-10.0	v
			J109	-2.0	-6.0	
On Charac	teristics					•
I _{DSS}	Zero-Gate Voltage Drain Current ⁽⁵⁾	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0$	MMBFJ108	80		mA
			J109	40		
r _{DS} (on)	Drain-Source On Resistance	$V_{DS} \leq 0.1 \text{ V}, \text{ V}_{GS} = 0$	MMBFJ108		8.0	Ω
			J109		12	
Small Sigr	al Characteristics					•
C _{dg} (on) C _{sg} (off)	Drain-Gate &Source-Gate On Capacitance	$V_{DS} = 0, V_{GS} = 0, f = 1.0 \text{ MHz}$			85	pF
C _{dg} (off)	Drain-Gate Off Capacitance	$V_{DS} = 0, V_{GS} = -10 \text{ V}, \text{ f} = 1.0 \text{ MHz}$			15	pF
C _{sg} (off)	Source-Gate Off Capacitance	V _{DS} = 0, V _{GS} = -10 V, f = 1.0 MHz			15	pF

Note:

5. Pulse test: pulse width \leq 300 $\mu s,$ duty cycle \leq 2%.



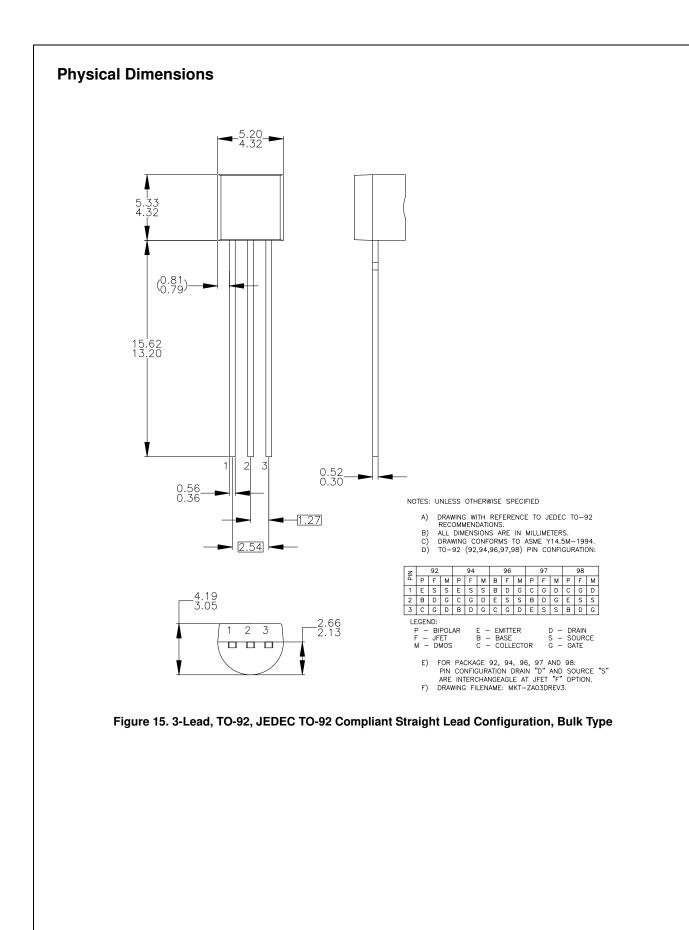
J109 / MMBFJ108 ---**N-Channel Switch**

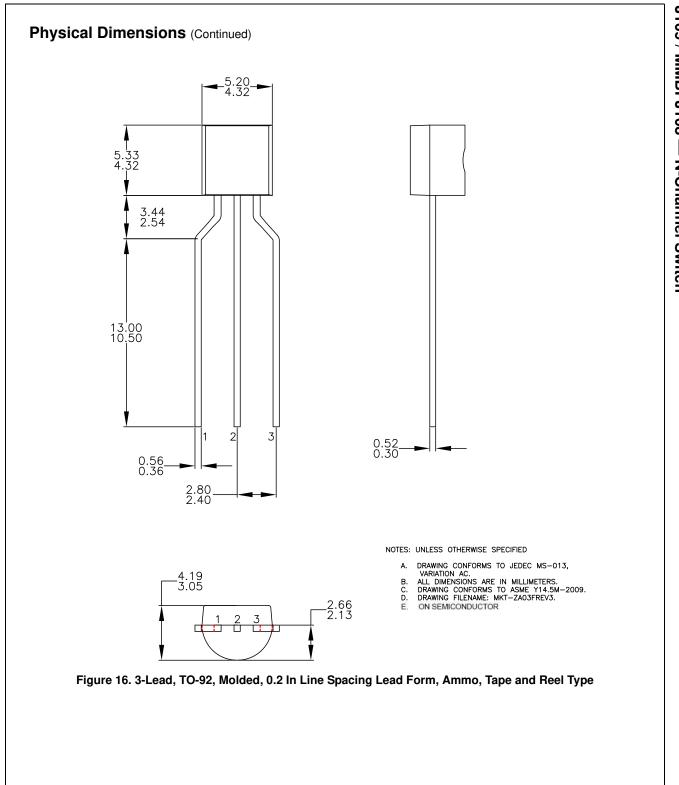
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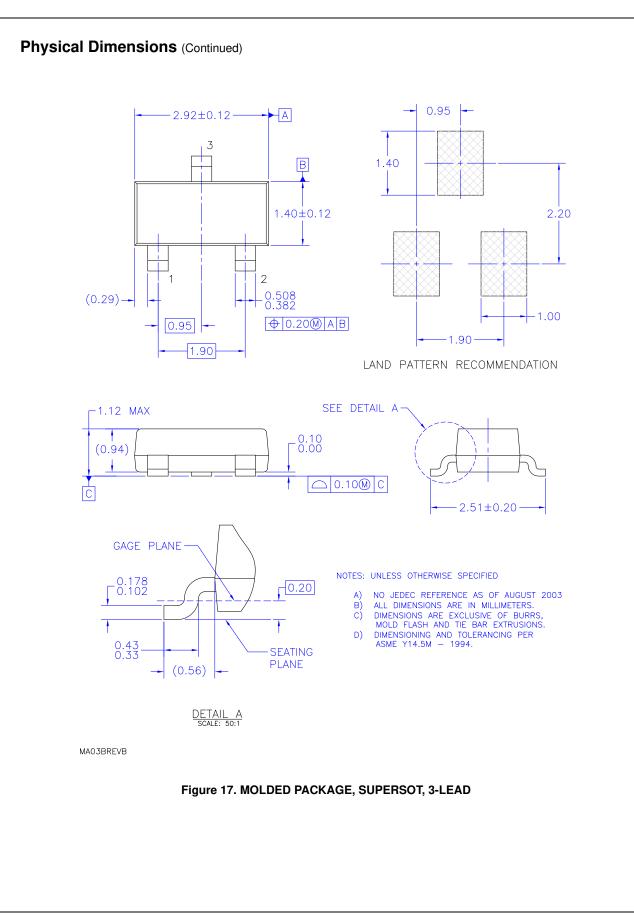
10

10 50 T_A = 25°C t OFF- TURN-OFF TIME (ns) 07 05 10 10 10 ton - TURN-ON TIME (ns) V_{DD} = 1.5V 8 V_{GS(off)} = -8.5V V _{GS(off)}= - 12V 5.5V V_{GS(off)} = · 6 I _D = 30 mA 3.5V V_{GS(off)} 4 T_A = 25 °C = 10 mA ם ו V_{DD} = 1.5V 2 'GS(off)= - 12V 0 0 0 -2 -4 -6 -8 -10 0 5 10 15 20 VGS(off) - GATE-SOURCE CUTOFF VOLTAGE (V) I_D - DRAIN CURRENT (mA) Figure 9. Switching Turn-On Time vs. Figure 10. Switching Turn-On Time vs. Drain Current Gate-Source Cut-Off Voltage g os - OUTPUT CONDUCTANCE (µmhos) - DRAIN "ON" RESISTANCE (0) 100 100 50 V_{GS(off)}=-3.0V VGS(o 125°C 125°C 4 0 10 10 1 ·⊁╡┼╞ 15V 5 25°C 55°C T_A = 25°C 25°C V_{GS(off)}= - 5.0V r _{DS} - 1.0V f = 1.0 kHz 1 ► 0.1 1 1 1 10 100 I D - DRAIN CURRENT (mA) I D - DRAIN CURRENT (mA) Figure 11. On Resistance vs. Drain Current Figure 12. Output Conductance vs. Drain Current g fs - TRANSCONDUCTANCE (mmhos) 100 T_A= 25℃ 55°C 700 V_{DG} = 10V 600 P_b - POWER DISSIPATION(mW) f = 1.0 kHz 500 TO-92 SuperSOT-3 400 10 300 - 1 0 GS(off) 200 V_{GS(off)} = -3.0V V_{GS(off)} = -5.0V 100 1 0.1 0 10 1 125 I_D - DRAIN CURRENT (mA) TEMPERATURE (°C) Figure 14. Power Dissipation vs. Figure 13. Transconductance vs. Drain Current **Ambient Temperature**

Typical Performance Characteristics (Continued)







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